TAI-SAW TECHNOLOGY CO., LTD.
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Product Specifications Approval Sheet

Product Description: Crystal Unit SMD 2.5x2.0 40.0MHz

TST Part No.: TZ1721A

Customer Part No.:_____

Customer signature required

Company:_____

Division:_____

Approved by :_____

Date:_____

Checked by: Kelly Huang Kelly Huang

Approved by: Robert Chang Kelly

Date: 8/12/2009

1. Customer signed back is required before TST can proceed with sample build and receive orders.
2. Orders received without customer signed back will be regarded as agreement on the specifications.
3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.

TAI-SAW TECHNOLOGY CO., LTD.

Crystal Unit SMD 2.5x2.0 40.0MHz

MODEL NO.: TZ1721A REV. NO.: 1

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	8/12/09’	N/A	Kelly Huang

TAI-SAW TECHNOLOGY CO., LTD.

Crystal Unit SMD 2.5x2.0 40.0MHz

MODEL NO.: TZ1721A REV. NO.: 1

Features:

RoHS Compliant
Lead free
Lead-free soldering

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package

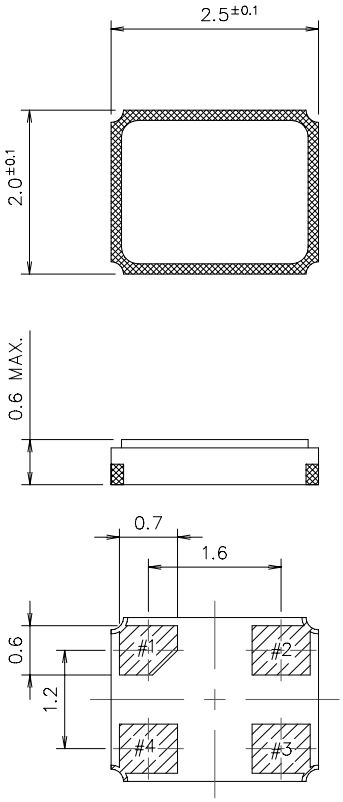
Description and Applications:

Surface mount 2.5mmx2.0mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

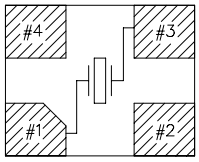
Nominal Frequency	40.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40°C to +85°C
Operating Temperature Range	-20°C to +85°C
Frequency Stability over Operating Temperature Range	+/-10 ppm (referred to the value at 25°C)
Frequency Make Tolerance (FL)	+/-8 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	50 Ω max
Nominal Drive Level	10uW typical, 200 uW max.
Shunt Capacitance (Co)	5.0 pF max
Load Capacitance (CL)	14 pF
Insulation Resistance	500 MΩ min./DC 100V
Aging	+/-1ppm/year
Marking	Laser Marking
Unit Weight	9.5 +/-0.5mg

Mechanical Dimensions (mm):



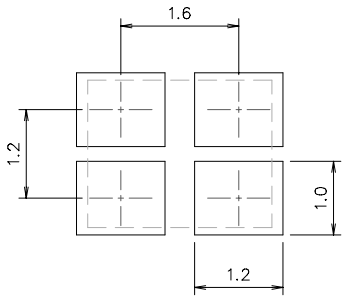
	Pin Connection
#1 pin	IN/OUT
#2 pin	GND
#3 pin	IN/OUT
#4 pin	GND

Internal Connections
(Top View)



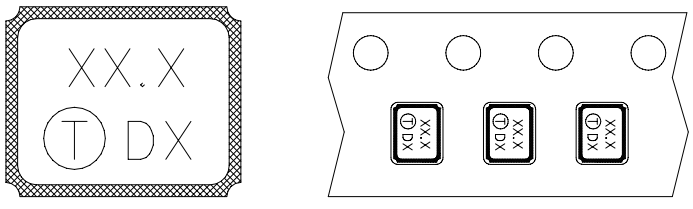
[NOTE] #2, #4 is connected with a cover
(Please connect with a GND ora power supply)

Recommended Land Pattern: (unit: mm)



Marking:

Line 1: Frequency (40.0)
Line 2: TST Logo + Date Code + Product Code



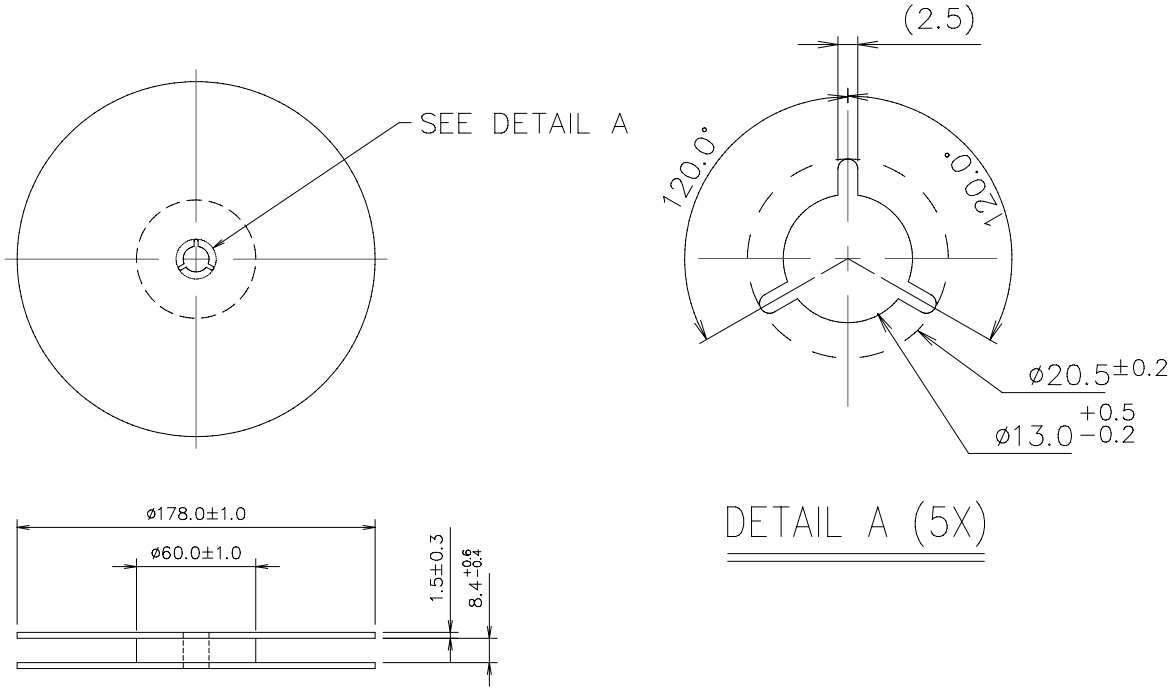
Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
A	B	C	D	E	F	G	H	I	J	K	L	M
WK14	**WK15**	**WK16**	**WK17**	**WK18**	**WK19**	**WK20**	**WK21**	**WK22**	**WK23**	**WK24**	**WK25**	**WK26**
N	O	P	Q	R	S	T	U	V	W	X	Y	Z
WK27	**WK28**	**WK29**	**WK30**	**WK31**	**WK32**	**WK33**	**WK34**	**WK35**	**WK36**	**WK37**	**WK38**	**WK39**
a	b	c	d	e	f	g	h	i	j	k	l	m
WK40	**WK41**	**WK42**	**WK43**	**WK44**	**WK45**	**WK46**	**WK47**	**WK48**	**WK49**	**WK50**	**WK51**	**WK52**
n	o	p	q	r	s	t	u	v	w	x	y	z

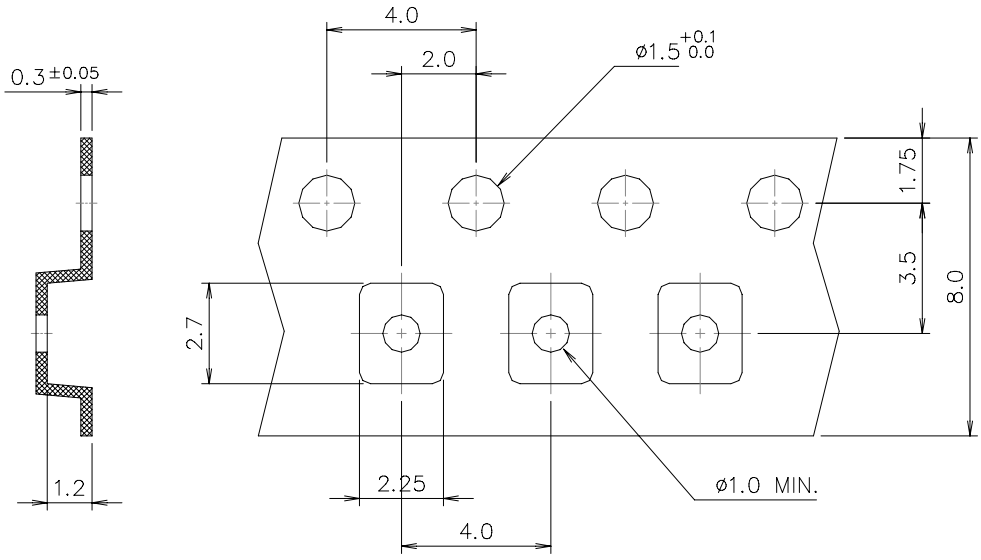
Product Code Table:

Year						product code
2009	2011	2013	2015	2017	2019	X
2010	2012	2014	2016	2018	2020	X

Reel Dimensions (mm):



Tape Dimensions (mm):

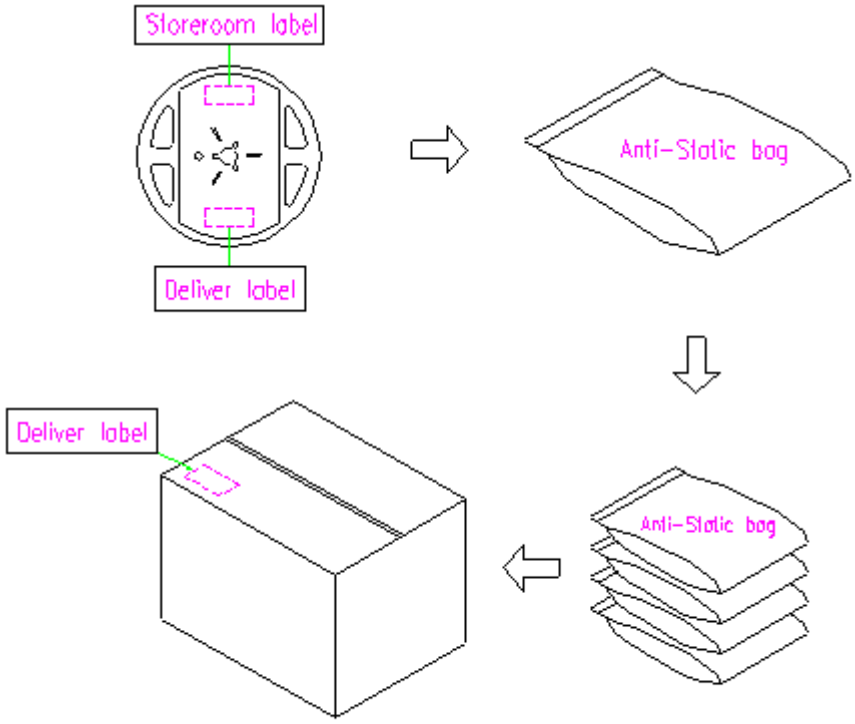


[NOTE]:

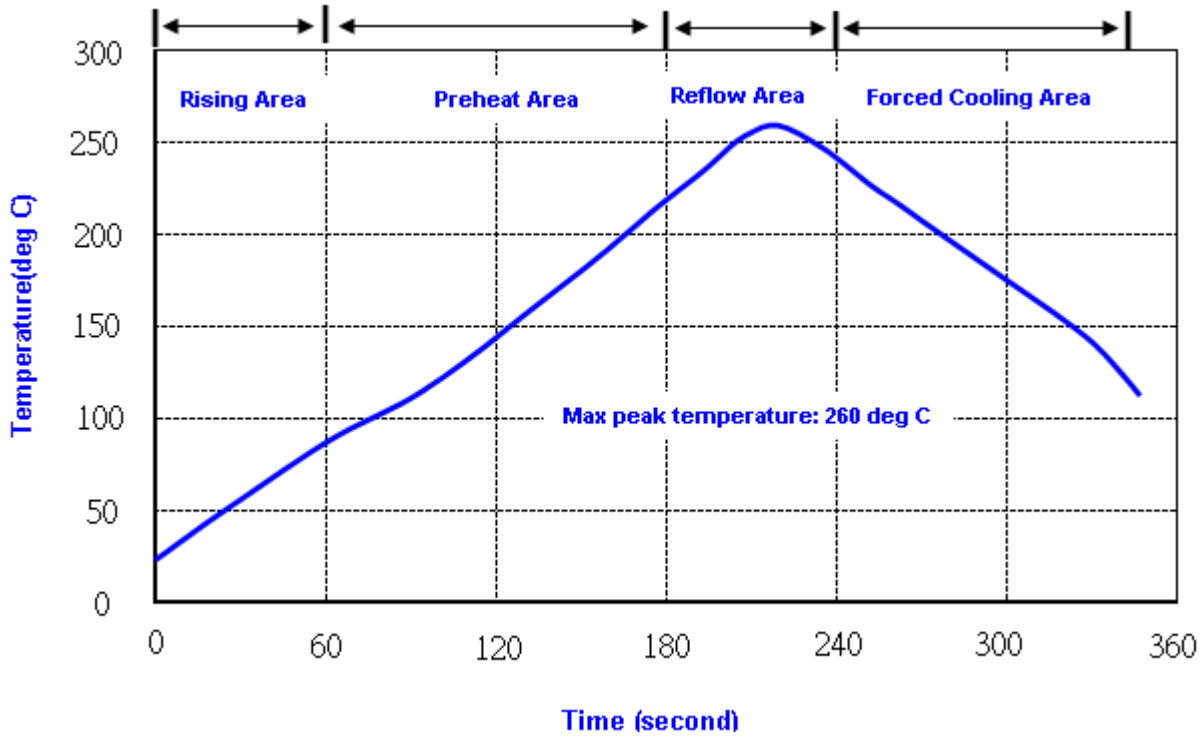
1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
2. Material: conductive polystyrene with color black.
3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications

Test name	Test process / method	Reference standard
Mechanical characteristics		
resistance to Soldering heat (IR reflow)	Temp./ Duration : 260°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 55 Hz Sweep period : 1.0 minute Vibration directions : 3 mutually perpendicular Duration : 2 hr / direc.	MIL-STD 202F method 201A
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202F method 213C
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	MIL-STD 883G method 2003
Environmental characteristics		
Thermal Shock	Heat cycle conditions -55 ℃ (30min) ⟷ 125 ℃ (30min) * cycle time : 10 times	MIL-STD 883G method 1010.7
Humidity test	Temperature : 70 ± 2 °C Relative humidity : 90~95% Duration : 96 hours	MIL-STD 202F method 103B
Dry heat (Aging test)	Temperature : 125 ± 2 °C Duration : 168 hours	MIL-STD 883G method 1008.2 condition C
PCT test	Pressure: 2.06kg/cm^2 (2.03*10^5 pa) Temperature : 121 ± 2 °C Relative humidity : 100% Duration : 24 hours	EIAJED-4701-3 B-123A